

COURSE CONTENT:		
UNIT I	LIGHT AND ILLUMINATION	9
<p>Basics about Light: Electromagnetic Spectrum, Visible Spectrum, Wavelength, Characterisations, Classification of Radiometry & Photometry - Natural & Artificial Light Sources - Characteristics about Light - Light and Vision - Evolution of Lighting Technologies - Merits and Demerits of the technologies - Instruments used for Measurement of Light Quantities.</p>		
UNIT II	LED TECHNOLOGY	9
<p>Physics of a LED - Electrical characteristics - Optical characteristics - Data Sheet interpretation - Types of LED's - Experimental Procedures for determination of the Characteristics - White LED Parameters - Solid State Luminaire - Solid State Luminaire Standards - Performance Measurements</p>		
UNIT III	POWER ELECTRONICS FOR LED LIGHTING	9
<p>LED Driver Requirements and Regional Standards – Topology Overview - Linear, Buck, Boost, Buck-Boost, Sepic & Fly-back) - Driving options - Discrete based drivers, Linear drivers, Switching drivers - AC-DC Drivers, Importance of Power Factor Correction (PFC), Single Stage vs 2-Stage Design, TRIAC Dimmable AC-DC Drivers - PWM IC</p>		
UNIT IV	LIGHT POWER & CONTROL	9
<p>Lighting control strategies, techniques & equipment, sensors and timers, switches versus dimming control algorithm, harmonics, EI from lighting equipment – its measurement & suppression techniques. Impact of lighting control, protocols for lighting control; Lighting control by computer, simple multi-channel & large multi-channel control, stage & entertainment lighting control, architectural & building lighting control systems; Centralised vs. distributed system; Status monitoring, fault monitoring, electrical load monitoring, lamp life monitoring system, applications</p>		
UNIT V	LED MANUFACTURING TECHNOLOGY	9
<p>Design Fundamentals of LED Lamps - Testing Of LED Lamps – SMD PCB Assembly technology – Screen printing, Pick & place Machines programming & practice, Reflow soldering, Hand Soldering, SMD REWORK & Repair, Dispensing, Coating, protection Optional ADVANCED: LED Packaging process- Diebonding, Wire bonding, Encapsulation etc.</p>		
TOTAL: 45 PERIODS		
TEXT BOOKS:		
<ol style="list-style-type: none"> 1. Optoelectronic Devices and Circuits, Theory and Applications, Amar K.Ganguly, Narosa Publishing House 2. Power Electronics, Dr.P.S.Bimbhra, Khanna Publishers. 		
REFERENCE BOOKS:		
<ol style="list-style-type: none"> 1. LIGHT-EMITTING DIODES E. FRED SCHUBERT , Cambridge University Press The Edinburgh Building, Cambridge, New York, Melbourne, Madrid, Cape Town, Singapore. 2. Light Design, Anil Valia, Published by Mili Jain 		